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### Details

Product Status	Active
Core Processor	ARM7®
Core Size	16/32-Bit
Speed	44MHz
Connectivity	EBI/EMI, I <sup>2</sup> C, SPI, UART/USART
Peripherals	PLA, PWM, PSM, Temp Sensor, WDT
Number of I/O	30
Program Memory Size	62KB (31K x16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 32
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 10x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	64-VFQFN Exposed Pad, CSP
Supplier Device Package	64-LFCSP-VQ (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/analog-devices/aduc7024bcpz62-rl7

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## Table 4. I<sup>2</sup>C Timing in Fast Mode (400 kHz)

		Slave		Master	
Parameter	Description	Min	Max	Тур	Unit
tL	SCL low pulse width <sup>1</sup>	200		1360	ns
tн	SCL high pulse width <sup>1</sup>	100		1140	ns
t <sub>shd</sub>	Start condition hold time	300			ns
<b>t</b> dsu	Data setup time	100		740	ns
t <sub>DHD</sub>	Data hold time	0		400	ns
t <sub>RSU</sub>	Setup time for repeated start	100			ns
t <sub>PSU</sub>	Stop condition setup time	100		400	ns
t <sub>BUF</sub>	Bus-free time between a stop condition and a start condition	1.3			μs
t <sub>R</sub>	Rise time for both SCL and SDA		300	200	ns
tF	Fall time for both SCL and SDA		300		ns
t <sub>sup</sub>	Pulse width of spike suppressed		50		ns

 $^1$  t\_{HCLK} depends on the clock divider or CD bits in the POWCON MMR. t\_{HCLK} = t\_{UCLK}/2^{CD}; see Figure 67.

## Table 5. I<sup>2</sup>C Timing in Standard Mode (100 kHz)

		Slave		Master	
Parameter	Description	Min	Max	Тур	Unit
t∟	SCL low pulse width <sup>1</sup>	4.7			μs
t <sub>H</sub>	SCL high pulse width <sup>1</sup>	4.0			ns
t <sub>shd</sub>	Start condition hold time	4.0			μs
t <sub>DSU</sub>	Data setup time	250			ns
<b>t</b> DHD	Data hold time	0	3.45		μs
t <sub>RSU</sub>	Setup time for repeated start	4.7			μs
<b>t</b> PSU	Stop condition setup time	4.0			μs
t <sub>BUF</sub>	Bus-free time between a stop condition and a start condition	4.7			μs
t <sub>R</sub>	Rise time for both SCL and SDA		1		μs
t <sub>F</sub>	Fall time for both SCL and SDA		300		ns

 $^{1}$  t<sub>HCLK</sub> depends on the clock divider or CD bits in the POWCON MMR. t<sub>HCLK</sub> = t<sub>UCLK</sub>/2<sup>CD</sup>; see Figure 67.



Figure 14. I<sup>2</sup>C Compatible Interface Timing

Pin No.				
7019/7020	7021	7022	Mnemonic	Description
22	22	21	P2.0/SPM9/PLAO[5]/CONV <sub>START</sub>	Serial Port Multiplexed. General-Purpose Input and Output Port 2.0/UART/ Programmable Logic Array Output Element 5/Start Conversion Input Signal for ADC.
23	23	22	P0.7/ECLK/XCLK/SPM8/PLAO[4]	Serial Port Multiplexed. General-Purpose Input and Output Port 0.7/ Output for External Clock Signal/Input to the Internal Clock Generator Circuits/UART/ Programmable Logic Array Output Element 4.
24	24	23	XCLKO	Output from the Crystal Oscillator Inverter.
25	25	24	XCLKI	Input to the Crystal Oscillator Inverter and Input to the Internal Clock Generator Circuits.
26	26	25	P1.7/SPM7/PLAO[0]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.7/UART, SPI/Programmable Logic Array Output Element 0.
27	27	26	P1.6/SPM6/PLAI[6]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.6/UART, SPI/Programmable Logic Array Input Element 6.
28	28	27	P1.5/SPM5/PLAI[5]/IRQ3	Serial Port Multiplexed. General-Purpose Input and Output Port 1.5/UART, SPI/Programmable Logic Array Input Element 5/External Interrupt Request 3, Active High.
29	29	28	P1.4/SPM4/PLAI[4]/IRQ2	Serial Port Multiplexed. General-Purpose Input and Output Port 1.4/UART, SPI/Programmable Logic Array Input Element 4/External Interrupt Request 2, Active High.
30	30	29	P1.3/SPM3/PLAI[3]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.3/UART, I2C1/Programmable Logic Array Input Element 3.
31	31	30	P1.2/SPM2/PLAI[2]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.2/UART, I2C1/Programmable Logic Array Input Element 2.
32	32	31	P1.1/SPM1/PLAI[1]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.1/UART, I2C0/Programmable Logic Array Input Element 1.
33	33	32	P1.0/T1/SPM0/PLAI[0]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.0/ Timer1 Input/UART, I2C0/Programmable Logic Array Input Element 0.
34	-	-	P4.2/PLAO[10]	General-Purpose Input and Output Port 4.2/Programmable Logic Array Output Element 10.
35	34	33	V <sub>REF</sub>	2.5 V Internal Voltage Reference. Must be connected to a 0.47 $\mu F$ capacitor when using the internal reference.
36	35	34	AGND	Analog Ground. Ground reference point for the analog circuitry.
37	36	35	AV <sub>DD</sub>	3.3 V Analog Power.
0	0	0	EP	Exposed Pad. The pin configuration for the ADuC7019/ADuC7020/ ADuC7021/ADuC7022 has an exposed pad that must be soldered for mechanical purposes and left unconnected.

Pin No.	Mnemonic	Description
37	P3.6/PWM <sub>TRIP</sub> /PLAI[14]	General-Purpose Input and Output Port 3.6/PWM Safety Cutoff/Programmable Logic Array Input Element 14.
38	P3.7/PWM <sub>SYNC</sub> /PLAI[15]	General-Purpose Input and Output Port 3.7/PWM Synchronization Input and Output/ Programmable Logic Array Input Element 15.
39	P1.7/SPM7/PLAO[0]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.7/UART, SPI/Programmable Logic Array Output Element 0.
40	P1.6/SPM6/PLAI[6]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.6/UART, SPI/Programmable Logic Array Input Element 6.
41	IOGND	Ground for GPIO (see Table 78). Typically connected to DGND.
42	IOV <sub>DD</sub>	3.3 V Supply for GPIO (see Table 78) and Input of the On-Chip Voltage Regulator.
43	P4.0/PLAO[8]	General-Purpose Input and Output Port 4.0/Programmable Logic Array Output Element 8.
44	P4.1/PLAO[9]	General-Purpose Input and Output Port 4.1/Programmable Logic Array Output Element 9.
45	P1.5/SPM5/PLAI[5]/IRQ3	Serial Port Multiplexed. General-Purpose Input and Output Port 1.5/UART, SPI/Programmable Logic Array Input Element 5/External Interrupt Request 3, Active High.
46	P1.4/SPM4/PLAI[4]/IRQ2	Serial Port Multiplexed. General-Purpose Input and Output Port 1.4/UART, SPI/Programmable Logic Array Input Element 4/External Interrupt Request 2, Active High.
47	P1.3/SPM3/PLAI[3]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.3/UART, I2C1/Programmable Logic Array Input Element 3.
48	P1.2/SPM2/PLAI[2]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.2/UART, I2C1/Programmable Logic Array Input Element 2.
49	P1.1/SPM1/PLAI[1]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.1/UART, I2CO/Programmable Logic Array Input Element 1.
50	P1.0/T1/SPM0/PLAI[0]	Serial Port Multiplexed. General-Purpose Input and Output Port 1.0/Timer1 Input/UART, I2C0/ Programmable Logic Array Input Element 0.
51	P4.2/PLAO[10]	General-Purpose Input and Output Port 4.2/Programmable Logic Array Output Element 10.
52	P4.3/PLAO[11]	General-Purpose Input and Output Port 4.3/Programmable Logic Array Output Element 11.
53	P4.4/PLAO[12]	General-Purpose Input and Output Port 4.4/Programmable Logic Array Output Element 12.
54	P4.5/PLAO[13]	General-Purpose Input and Output Port 4.5/Programmable Logic Array Output Element 13.
55	V <sub>REF</sub>	2.5 V Internal Voltage Reference. Must be connected to a 0.47 $\mu F$ capacitor when using the internal reference.
56	DAC <sub>REF</sub>	External Voltage Reference for the DACs. Range: DACGND to $DACV_{DD}$ .
57	DACGND	Ground for the DAC. Typically connected to AGND.
58	AGND	Analog Ground. Ground reference point for the analog circuitry.
59	AV <sub>DD</sub>	3.3 V Analog Power.
60		3.3 V Power Supply for the DACs. Must be connected to $AV_{DD}$ .
61	ADC0	Single-Ended or Differential Analog Input 0.
62	ADC1	Single-Ended or Differential Analog Input 1.
63	ADC2/CMP0	Single-Ended or Differential Analog Input 2/Comparator Positive Input.
64	ADC3/CMP1	Single-Ended or Differential Analog Input 3/Comparator Negative Input.
0	EP	Exposed Pad. The pin configuration for the ADuC7024/ADuC7025 LFCSP_VQ has an exposed pad that must be soldered for mechanical purposes and left unconnected.

## ADuC7026/ADuC7027



*Figure 25. 80-Lead LQFP Pin Configuration (ADuC7026/ADuC7027)* 



Pin No.	Mnemonic	Description
1	ADC4	Single-Ended or Differential Analog Input 4.
2	ADC5	Single-Ended or Differential Analog Input 5.
3	ADC6	Single-Ended or Differential Analog Input 6.
4	ADC7	Single-Ended or Differential Analog Input 7.
5	ADC8	Single-Ended or Differential Analog Input 8.
6	ADC9	Single-Ended or Differential Analog Input 9.
7	ADC10	Single-Ended or Differential Analog Input 10.
8	GND <sub>REF</sub>	Ground Voltage Reference for the ADC. For optimal performance, the analog power supply should be separated from IOGND and DGND.
9	ADCNEG	Bias Point or Negative Analog Input of the ADC in Pseudo Differential Mode. Must be connected to the signal to convert. This bias point must be between 0 V and 1 V.
10	DAC0/ADC12	DAC0 Voltage Output/Single-Ended or Differential Analog Input 12. DAC outputs are not present on the ADuC7027.
11	DAC1/ADC13	DAC1 Voltage Output/Single-Ended or Differential Analog Input 13. DAC outputs are not present on the ADuC7027.
12	DAC2/ADC14	DAC2 Voltage Output/Single-Ended or Differential Analog Input 14. DAC outputs are not present on the ADuC7027.
13	DAC3/ADC15	DAC3 Voltage Output/Single-Ended or Differential Analog Input 15. DAC outputs are not present on the ADuC7027.
14	TMS	JTAG Test Port Input, Test Mode Select. Debug and download access.
15	TDI	JTAG Test Port Input, Test Data In. Debug and download access.
16	P0.1/PWM2 <sub>H</sub> /BLE	General-Purpose Input and Output Port 0.1/PWM Phase 2 High-Side Output/External Memory Byte Low Enable.
17	P2.3/AE	General-Purpose Input and Output Port 2.3/External Memory Access Enable.

Pin No.	Mnemonic	Description
18	P4.6/AD14/PLAO[14]	General-Purpose Input and Output Port 4.6/External Memory Interface/Programmable Logic Array Output Element 14.
19	P4.7/AD15/PLAO[15]	General-Purpose Input and Output Port 4.7/External Memory Interface/Programmable Logic Array Output Element 15.
20	BM/P0.0/CMP <sub>out</sub> /PLAI[7]/MS0	Multifunction I/O Pin. Boot Mode. The ADuC7026/ADuC7027 enter UART download mode if BM is low at reset and execute code if BM is pulled high at reset through a 1 k $\Omega$ resistor/General-Purpose Input and Output Port 0.0/Voltage Comparator Output/Programmable Logic Array Input Element 7/External Memory Select 0.
21	P0.6/T1/MRST/PLAO[3]	Multifunction Pin, Driven Low After Reset. General-Purpose Output Port 0.6/Timer1 Input/ Power-On Reset Output/Programmable Logic Array Output Element 3.
22	ТСК	JTAG Test Port Input, Test Clock. Debug and download access.
23	TDO	JTAG Test Port Output, Test Data Out. Debug and download access.
24	P0.2/PWM2 <sub>L</sub> /BHE	General-Purpose Input and Output Port 0.2/PWM Phase 2 Low-Side Output/External Memory Byte High Enable.
25	IOGND	Ground for GPIO (see Table 78). Typically connected to DGND.
26	IOV <sub>DD</sub>	3.3 V Supply for GPIO (see Table 78) and Input of the On-Chip Voltage Regulator.
27	LV <sub>DD</sub>	2.6 V Output of the On-Chip Voltage Regulator. This output must be connected to a 0.47 $\mu\text{F}$ capacitor to DGND only.
28	DGND	Ground for Core Logic.
29	P3.0/AD0/PWM0 <sub>H</sub> /PLAI[8]	General-Purpose Input and Output Port 3.0/External Memory Interface/PWM Phase 0 High-Side Output/Programmable Logic Array Input Element 8.
30	P3.1/AD1/PWM0∟/PLAI[9]	General-Purpose Input and Output Port 3.1/External Memory Interface/PWM Phase 0 Low-Side Output/Programmable Logic Array Input Element 9.
31	P3.2/AD2/PWM1 <sub>H</sub> /PLAI[10]	General-Purpose Input and Output Port 3.2/External Memory Interface/PWM Phase 1 High-Side Output/Programmable Logic Array Input Element 10.
32	P3.3/AD3/PWM1L/PLAI[11]	General-Purpose Input and Output Port 3.3/External Memory Interface/PWM Phase 1 Low-Side Output/Programmable Logic Array Input Element 11.
33	P2.4/PWM0 <sub>H</sub> /MS0	General-Purpose Input and Output Port 2.4/PWM Phase 0 High-Side Output/External Memory Select 0.
34	P0.3/TRST/A16/ADC <sub>BUSY</sub>	General-Purpose Input and Output Port 0.3/JTAG Test Port Input, Test Reset/ADC <sub>BUSY</sub> Signal Output.
35	P2.5/PWM0∟/MS1	General-Purpose Input and Output Port 2.5/PWM Phase 0 Low-Side Output/External Memory Select 1.
36	P2.6/PWM1 <sub>H</sub> /MS2	General-Purpose Input and Output Port 2.6/PWM Phase 1 High-Side Output/External Memory Select 2.
37	RST	Reset Input, Active Low.
38	P3.4/AD4/PWM2 <sub>H</sub> /PLAI[12]	General-Purpose Input and Output Port 3.4/External Memory Interface/PWM Phase 2 High-Side Output/Programmable Logic Array Input 12.
39	P3.5/AD5/PWM2L/PLAI[13]	General-Purpose Input and Output Port 3.5/External Memory Interface/PWM Phase 2 Low-Side Output/Programmable Logic Array Input Element 13.
40	IRQ0/P0.4/PWM <sub>TRIP</sub> /PLAO[1]/MS1	Multifunction I/O Pin. External Interrupt Request 0, Active High/General-Purpose Input and Output Port 0.4/PWM Trip External Input/Programmable Logic Array Output Element 1/ External Memory Select 1.
41	IRQ1/P0.5/ADC <sub>BUSY</sub> /PLAO[2]/MS2	Multifunction I/O Pin. External Interrupt Request 1, Active High/General-Purpose Input and Output Port 0.5/ADC <sub>BUSY</sub> Signal Output/Programmable Logic Array Output Element 2/External Memory Select 2.
42	P2.0/SPM9/PLAO[5]/CONV <sub>START</sub>	Serial Port Multiplexed. General-Purpose Input and Output Port 2.0/UART/Programmable Logic Array Output Element 5/Start Conversion Input Signal for ADC.
43	P0.7/ECLK/XCLK/SPM8/PLAO[4]	Serial Port Multiplexed. General-Purpose Input and Output Port 0.7/Output for External Clock
		Signal/Input to the Internal Clock Generator Circuits/UART/Programmable Logic Array Output Element 4.
44	XCLKO	Output from the Crystal Oscillator Inverter.
45	XCLKI	Input to the Crystal Oscillator Inverter and Input to the Internal Clock Generator Circuits.





















Figure 39. Current Consumption vs. Temperature @ CD = 0

0xFFFFFFFF		
0xFFFFFC3C	DW/M	
0xFFFFFC00	F VVIVI	
0xFFFFF820		
0xFFFFF800	INTERFACE	
0xEEEEE46C		
0xFFFFF400	GPIO	
0xFFFF0B54		
0xFFFF0B00	PLA	
0xFFFF0A14		
0xFFFF0A00	SPI	
0xFFFF0948		
0xFFFF0900	12C1	
0vFFFF0848		
0xFFFF0800	I2C0	
0xFFFF0730		
0xFFFF0700	UART	
0xFFFF0620		
0xFFFF0600	DAC	
0xFFFF0538		
0xFFFF0500	ADC	
0xFFFF0490	BAND GAP	
0xFFFF048C	REFERENCE	
0xFFFF0448	POWER SUPPLY	
0xFFFF0440	MONITOR	
0xFFFF0420	PLL AND	
0xFFFF0404	OSCILLATOR CONTROL	
0xFFFF0370	WATCHDOG	
0xFFFF0360		
0xFFFF0350	WAKE-UP	
0xFFFF0340	HIMER	
0xFFFF0334	GENERAL-PURPOSE	
0xFFFF0320		
0xFFFF0310	TIMER 0	
0xFFFF0300		
0xFFFF0238	REMAP AND	
0xFFFF0220	STSTEM CONTROL	
0xFFFF0110	INTERRUPT CONTROLLER	955-010
0xFFFF0000		8

Figure 47. Memory Mapped Registers

## Table 16. Complete MMR List

Address	Name	Byte	Access Type	Default Value	Page
IRQ Addre	ss Base = 0xFF	FF0000			
0x0000	IRQSTA	4	R	0x00000000	83
0x0004	IRQSIG <sup>1</sup>	4	R	0x00XXX000	83
0x0008	IRQEN	4	R/W	0x00000000	83
0x000C	IRQCLR	4	W	0x00000000	83
0x0010	SWICFG	4	W	0x00000000	84
0x0100	FIQSTA	4	R	0x00000000	84
0x0104	FIQSIG <sup>1</sup>	4	R	0x00XXX000	84
0x0108	FIQEN	4	R/W	0x00000000	84
0x010C	FIQCLR	4	W	0x00000000	84

<sup>1</sup> Depends on the level on the external interrupt pins (P0.4, P0.5, P1.4, and P1.5).

## System Control Address Base = 0xFFF0200

0x0220	REMAP	1	R/W	0xXX <sup>1</sup>	55
0x0230	RSTSTA	1	R/W	0x01	55
0x0234	RSTCLR	1	W	0x00	55

<sup>1</sup>Depends on the model.

## Timer Address Base = 0xFFFF0300

0x0300	TOLD	2	R/W	0x0000	85
0x0304	TOVAL	2	R	0xFFFF	85
0x0308	T0CON	2	R/W	0x0000	85
0x030C	TOCLRI	1	W	0xFF	85
0x0320	T1LD	4	R/W	0x00000000	86
0x0324	T1VAL	4	R	0xFFFFFFFF	86
0x0328	T1CON	2	R/W	0x0000	86
0x032C	T1CLRI	1	W	0xFF	87
0x0330	T1CAP	4	R/W	0x00000000	87
0x0340	T2LD	4	R/W	0x00000000	87
0x0344	T2VAL	4	R	0xFFFFFFFF	87
0x0348	T2CON	2	R/W	0x0000	87
0x034C	T2CLRI	1	W	0xFF	88
0x0360	T3LD	2	R/W	0x0000	88
0x0364	T3VAL	2	R	0xFFFF	88
0x0368	T3CON	2	R/W	0x0000	88
0x036C	T3CLRI	1	W	0x00	89

## PLL Base Address = 0xFFFF0400

60
60
60
60
60
60
6

#### PSM Address Base = 0xFFFF0440

0x0440	PSMCON	2	R/W	0x0008	57
0x0444	CMPCON	2	R/W	0x0000	58

## Table 18. ADCCON MMR Bit Designations

Bit	Value	Description
15:13		Reserved.
12:10		ADC clock speed.
	000	fADC/1. This divider is provided to obtain 1 MSPS ADC with an external clock <41.78 MHz.
	001	fADC/2 (default value).
	010	fADC/4.
	011	fADC/8.
	100	fADC/16.
	101	fADC/32.
9:8		ADC acquisition time.
	00	Two clocks.
	01	Four clocks.
	10	Eight clocks (default value).
	11	16 clocks.
7		Enable start conversion.
		Set by the user to start any type of conversion command. Cleared by the user to disable a start conversion (clearing this bit does not stop the ADC when continuously converting)
6		Posonvod
0		Reserved.
5		ADC power control
		Set by the user to place the ADC in normal mode (the ADC must be powered up for at least
		5 μs before it converts correctly). Cleared by the user to place the ADC in power-down mode.
4:3		Conversion mode.
	00	Single-ended mode.
	01	Differential mode.
	10	Pseudo differential mode.
	11	Reserved.
2:0		Conversion type.
	000	Enable CONV <sub>START</sub> pin as a conversion input.
	001	Enable Timer1 as a conversion input.
	010	Enable Timer0 as a conversion input.
	011	Single software conversion. Sets to 000 after conversion (note that Bit 7 of ADCCON MMR should be cleared after starting a single software conversion to avoid <u>further</u> conversions triggered by the CONV <sub>START</sub> pin).
	100	Continuous software conversion.
	101	PLA conversion.
	Other	Reserved.

## Table 19. ADCCP Register

\_

	Deluarevalue	Access
ADCCP 0xFFFF0504	0x00	R/W

ADCCP is an ADC positive channel selection register. This MMR is described in Table 20.

## Table 20. ADCCP<sup>1</sup> MMR Bit Designation

Bit	Value	Description
7:5		Reserved.
4:0		Positive channel selection bits.
	00000	ADC0.
	00001	ADC1.
	00010	ADC2.
	00011	ADC3.
	00100	ADC4.
	00101	ADC5.
	00110	ADC6.
	00111	ADC7.
	01000	ADC8.
	01001	ADC9.
	01010	ADC10.
	01011	ADC11.
	01100	DAC0/ADC12.
	01101	DAC1/ADC13.
	01110	DAC2/ADC14.
	01111	DAC3/ADC15.
	10000	Temperature sensor.
	10001	AGND (self-diagnostic feature).
	10010	Internal reference (self-diagnostic feature).
	10011	AV <sub>DD</sub> /2.
	Others	Reserved.

<sup>1</sup> ADC and DAC channel availability depends on the part model. See Ordering Guide for details.

## Table 21. ADCCN Register

Name	Address	Default Value	Access
ADCCN	0xFFFF0508	0x01	R/W

ADCCN is an ADC negative channel selection register. This MMR is described in Table 22.

## **DESCRIPTION OF THE PWM BLOCK**

A functional block diagram of the PWM controller is shown in Figure 68. The generation of the six output PWM signals on Pin PWM0<sub>H</sub> to Pin PWM2<sub>L</sub> is controlled by the following four important blocks:

- The 3-phase PWM timing unit. The core of the PWM controller, this block generates three pairs of complemented and dead-time-adjusted, center-based PWM signals. This unit also generates the internal synchronization pulse, PWMSYNC. It also controls whether the external PWM<sub>SYNC</sub> pin is used.
- The output control unit. This block can redirect the outputs of the 3-phase timing unit for each channel to either the high-side or low-side output. In addition, the output control unit allows individual enabling/disabling of each of the six PWM output signals.
- The gate drive unit. This block can generate the high frequency chopping and its subsequent mixing with the PWM signals.
- The PWM shutdown controller. This block controls the PWM shutdown via the PWM<sub>TRIP</sub> pin and generates the correct reset signal for the timing unit.

The PWM controller is driven by the ADuC7019/20/21/22/24/ 25/26/27/28/29 core clock frequency and is capable of generating two interrupts to the ARM core. One interrupt is generated on the occurrence of a PWMSYNC pulse, and the other is generated on the occurrence of any PWM shutdown action.

## 3-Phase Timing Unit

## PWM Switching Frequency (PWMDAT0 MMR)

The PWM switching frequency is controlled by the PWM period register, PWMDAT0. The fundamental timing unit of the PWM controller is

 $t_{CORE} = 1/f_{CORE}$ 

where  $f_{CORE}$  is the core frequency of the MicroConverter.

Therefore, for a 41.78 MHz  $f_{\rm CORE}$ , the fundamental time increment is 24 ns. The value written to the PWMDAT0 register is effectively the number of  $f_{\rm CORE}$  clock increments in one-half a PWM period. The required PWMDAT0 value is a function of the desired PWM switching frequency ( $f_{\rm PWN}$ ) and is given by

 $PWMDAT0 = f_{CORE}/(2 \times f_{PWM})$ 

Therefore, the PWM switching period, ts, can be written as

 $t_{S} = 2 \times PWMDAT0 \times t_{CORE}$ 

The largest value that can be written to the 16-bit PWMDAT0 MMR is 0xFFFF = 65,535, which corresponds to a minimum PWM switching frequency of

 $f_{PWM(min)} = 41.78 \times 10^{6}/(2 \times 65,535) = 318.75 \text{ Hz}$ 

Note that PWMDAT0 values of 0 and 1 are not defined and should not be used.

## PWM Switching Dead Time (PWMDAT1 MMR)

The second important parameter that must be set up in the initial configuration of the PWM block is the switching dead time. This is a short delay time introduced between turning off one PWM signal (0H, for example) and turning on the complementary signal (0L). This short time delay is introduced to permit the power switch to be turned off (in this case, 0H) to completely recover its blocking capability before the complementary switch is turned on. This time delay prevents a potentially destructive short-circuit condition from developing across the dc link capacitor of a typical voltage source inverter.

The dead time is controlled by the 10-bit, read/write PWMDAT1 register. There is only one dead-time register that controls the dead time inserted into all three pairs of PWM output signals. The dead time,  $t_D$ , is related to the value in the PWMDAT1 register by

### $t_D = PWMDAT1 \times 2 \times t_{CORE}$

Therefore, a PWMDAT1 value of 0x00A (= 10), introduces a 426 ns delay between the turn-off on any PWM signal (0H, for example) and the turn-on of its complementary signal (0L). The amount of the dead time can, therefore, be programmed in increments of  $2t_{CORE}$  (or 49 ns for a 41.78 MHz core clock).



Figure 68. Overview of the PWM Controller

Both switching edges are moved by an equal amount (PWMDAT1  $\times$   $t_{\rm CORE}$ ) to preserve the symmetrical output patterns.

Also shown are the PWMSYNC pulse and Bit 0 of the PWMSTA register, which indicates whether operation is in the first or second half cycle of the PWM period.

The resulting on times of the PWM signals over the full PWM period (two half periods) produced by the timing unit can be written as follows:

On the high side

 $t_{OHH} = PWMDAT0 + 2(PWMCH0 - PWMDAT1) \times t_{CORE}$ 

 $t_{OHL} = PWMDAT0 - 2(PWMCH0 - PWMDAT1) \times t_{CORE}$ 

and the corresponding duty cycles (d)

 $d_{0H} = t_{0HH}/t_s = \frac{1}{2} + (PWMCH0 - PWMDAT1)/PWMDAT0$ and on the low side

 $t_{0LH} = PWMDAT0 - 2(PWMCH0 + PWMDAT1) \times t_{CORE}$ 

 $t_{oll} = PWMDAT0 + 2(PWMCH0 + PWMDAT1) \times t_{CORE}$ 

and the corresponding duty cycles (d)

 $d_{OL} = t_{OLH}/t_S = \frac{1}{2} - (PWMCH0 + PWMDAT1)/PWMDAT0$ 

The minimum permissible  $t_{0H}$  and  $t_{0L}$  values are zero, corresponding to a 0% duty cycle. In a similar fashion, the maximum value is  $t_s$ , corresponding to a 100% duty cycle.

Figure 70 shows the output signals from the timing unit for operation in double update mode. It illustrates a general case where the switching frequency, dead time, and duty cycle are all changed in the second half of the PWM period. The same value for any or all of these quantities can be used in both halves of the PWM cycle. However, there is no guarantee that symmetrical PWM signals are produced by the timing unit in double update mode. Figure 70 also shows that the dead time insertions into the PWM signals are done in the same way as in single update mode.



(Double Update Mode)

In general, the on times of the PWM signals in double update mode can be defined as follows:

On the high side

 $t_{0HH} = (PWMDAT0_1/2 + PWMDAT0_2/2 + PWMCH0_1 + PWMCH0_2 - PWMDAT1_1 - PWMDAT1_2) \times t_{CORE}$ 

 $t_{0HL} = (PWMDAT0_1/2 + PWMDAT0_2/2 - PWMCH0_1 - PWMCH0_2 + PWMDAT1_1 + PWMDAT1_2) \times t_{CORE}$ 

where Subscript *1* refers to the value of that register during the first half cycle, and Subscript *2* refers to the value during the second half cycle.

The corresponding duty cycles (d) are

 $d_{0H} = t_{0HH}/t_s = (PWMDAT0_1/2 + PWMDAT0_2/2 + PWMCH0_1 + PWMCH0_2 - PWMDAT1_1 - PWMDAT1_2)/$ (PWMDAT0\_1 + PWMDAT0\_2)

On the low side

 $t_{0LH} = (PWMDAT0_1/2 + PWMDAT0_2/2 + PWMCH0_1 + PWMCH0_2 + PWMDAT1_1 + PWMDAT1_2) \times t_{CORE}$ 

 $t_{oLL} = (PWMDAT0_1/2 + PWMDAT0_2/2 - PWMCH0_1 - PWMCH0_2 - PWMDAT1_1 - PWMDAT1_2) \times t_{CORE}$ 

where Subscript *1* refers to the value of that register during the first half cycle, and Subscript *2* refers to the value during the second half cycle.

The corresponding duty cycles (d) are

 $d_{0L} = t_{0LH}/t_{S} = (PWMDAT0_{1}/2 + PWMDAT0_{2}/2 + PWMCH0_{1} + PWMCH0_{2} + PWMDAT1_{1} + PWMDAT1_{2})/(PWMDAT0_{1} + PWMDAT0_{2})$ 

For the completely general case in double update mode (see Figure 70), the switching period is given by

 $t_{S} = (PWMDATO_{1} + PWMDATO_{2}) \times t_{CORE}$ 

Again, the values of  $t_{0H}$  and  $t_{0L}$  are constrained to lie between zero and  $t_{\text{S}}.$ 

PWM signals similar to those illustrated in Figure 69 and Figure 70 can be produced on the 1H, 1L, 2H, and 2L outputs by programming the PWMCH1 and PWMCH2 registers in a manner identical to that described for PWMCH0. The PWM controller does not produce any PWM outputs until all of the PWMDAT0, PWMCH0, PWMCH1, and PWMCH2 registers have been written to at least once. When these registers are written, internal counting of the timers in the 3-phase timing unit is enabled.

Writing to the PWMDAT0 register starts the internal timing of the main PWM timer. Provided that the PWMDAT0 register is written to prior to the PWMCH0, PWMCH1, and PWMCH2 registers in the initialization, the first PWMSYNC pulse and interrupt (if enabled) appear  $1.5 \times t_{CORE} \times PWMDAT0$  seconds after the initial write to the PWMDAT0 register in single update mode. In double update mode, the first PWMSYNC pulse appears after PWMDAT0 × t\_{CORE} seconds.

### Table 70. PWMCFG Register

Name	Address	Default Value	Access
PWMCFG	0xFFFFFC10	0x0000	R/W

PWMCFG is a gate chopping register.

#### Table 71. PWMCFG MMR Bit Descriptions

Bit	Name	Description
15:10		Reserved.
9	CHOPLO	Low-side gate chopping enable bit.
8	CHOPHI	High-side gate chopping enable bit.
7:0	GDCLK	PWM gate chopping period (unsigned).

#### Table 72. PWMEN Register

Name	Address	Default Value	Access
PWMEN	0xFFFFFC20	0x0000	R/W

PWMEN allows enabling of channel outputs and crossover. See its bit definitions in Table 73.

#### Table 73. PWMEN MMR Bit Descriptions

Bit	Name	Description
8	0H0L_XOVR	Channel 0 output crossover enable bit. Set to 1 by user to enable Channel 0 output crossover. Cleared to 0 by user to disable Channel 0 output crossover.
7	1H1L_XOVR	Channel 1 output crossover enable bit. Set to 1 by user to enable Channel 1 output crossover. Cleared to 0 by user to disable Channel 1 output crossover.
6	2H2L_XOVR	Channel 2 output crossover enable bit. Set to 1 by user to enable Channel 2 output crossover. Cleared to 0 by user to disable Channel 2 output crossover.
5	OL_EN	0L output enable bit. Set to 1 by user to disable the 0L output of the PWM. Cleared to 0 by user to enable the 0L output of the PWM.
4	OH_EN	0H output enable bit. Set to 1 by user to disable the 0H output of the PWM. Cleared to 0 by user to enable the 0H output of the PWM.
3	1L_EN	1L output enable bit. Set to 1 by user to disable the 1L output of the PWM. Cleared to 0 by user to enable the 1L output of the PWM.
2	1H_EN	1H Output Enable Bit. Set to 1 by user to disable the 1H output of the PWM. Cleared to 0 by user to enable the 1H output of the PWM.
1	2L_EN	2L output enable bit. Set to 1 by user to disable the 2L output of the PWM. Cleared to 0 by user to enable the 2L output of the PWM.
0	2H_EN	2H output enable bit. Set to 1 by user to disable the 2H output of the PWM. Cleared to 0 by user to enable the 2H output of the PWM.

### Table 74. PWMDAT0 Register

Name	Address	Default Value	Access
PWMDAT0	0xFFFFFC08	0x0000	R/W

PWMDAT0 is an unsigned 16-bit register for switching period.

#### Table 75. PWMDAT1 Register

Name	Address	Default Value	Access
PWMDAT1	0xFFFFFC0C	0x0000	R/W

PWMDAT1 is an unsigned 10-bit register for dead time.

#### Table 76. PWMCHx Registers

Name	Address	Default Value	Access
PWMCH0	0xFFFFFC14	0x0000	R/W
PWMCH1	0xFFFFFC18	0x0000	R/W
PWMCH2	0xFFFFFC1C	0x0000	R/W

PWMCH0, PWMCH1, and PWMCH2 are channel duty cycles for the three phases.

#### Table 77. PWMDAT2 Register

	0		
Name	Address	Default Value	Access
PWMDAT2	0xFFFFFC24	0x0000	R/W

PWMDAT2 is an unsigned 10-bit register for PWM sync pulse width.

## **GENERAL-PURPOSE INPUT/OUTPUT**

The ADuC7019/20/21/22/24/25/26/27/28/29 provide 40 general-purpose, bidirectional I/O (GPIO) pins. All I/O pins are 5 V tolerant, meaning the GPIOs support an input voltage of 5 V.

In general, many of the GPIO pins have multiple functions (see Table 78 for the pin function definitions). By default, the GPIO pins are configured in GPIO mode.

All GPIO pins have an internal pull-up resistor (of about 100 k $\Omega$ ), and their drive capability is 1.6 mA. Note that a maximum of 20 GPIOs can drive 1.6 mA at the same time. Using the GPxPAR registers, it is possible to enable/disable the pull-up resistors for the following ports: P0.0, P0.4, P0.5, P0.6, P0.7, and the eight GPIOs of P1.

The 40 GPIOs are grouped in five ports, Port 0 to Port 4 (Port x). Each port is controlled by four or five MMRs.

Note that the kernel changes P0.6 from its default configuration at reset (MRST) to GPIO mode. If MRST is used for external circuitry, an external pull-up resistor should be used to ensure that the level on P0.6 does not drop when the kernel switches mode. Otherwise, P0.6 goes low for the reset period. For example, if MRST is required for power-down, it can be reconfigured in GP0CON MMR.

The input level of any GPIO can be read at any time in the GPxDAT MMR, even when the pin is configured in a mode other than GPIO. The PLA input is always active.

When the ADuC7019/20/21/22/24/25/26/27/28/29 part enters a power-saving mode, the GPIO pins retain their state.

		Configuration			
Port	Pin	00	01	10	11
0	P0.0	GPIO	CMP	MS0	PLAI[7]
	P0.1	GPIO	PWM2 <sub>H</sub>	BLE	
	P0.2	GPIO	PWM2 <sub>L</sub>	BHE	
	P0.3	GPIO	TRST	A16	ADCBUSY
	P0.4	GPIO/IRQ0	PWM <sub>TRIP</sub>	MS1	PLAO[1]
	P0.5	GPIO/IRQ1	ADCBUSY	MS2	PLAO[2]
	P0.6	GPIO/T1	MRST		PLAO[3]
	P0.7	GPIO	ECLK/XCLK <sup>1</sup>	SIN	PLAO[4]
1	P1.0	GPIO/T1	SIN	SCL0	PLAI[0]
	P1.1	GPIO	SOUT	SDA0	PLAI[1]
	P1.2	GPIO	RTS	SCL1	PLAI[2]
	P1.3	GPIO	CTS	SDA1	PLAI[3]
	P1.4	GPIO/IRQ2	RI	SCLK	PLAI[4]
	P1.5	GPIO/IRQ3	DCD	MISO	PLAI[5]
	P1.6	GPIO	DSR	MOSI	PLAI[6]
	P1.7	GPIO	DTR	CS	PLAO[0]
2	P2.0	GPIO		SOUT	PLAO[5]
	P2.1	GPIO	PWM0 <sub>H</sub>	WS	PLAO[6]
	P2.2	GPIO	PWM0L	RS	PLAO[7]
	P2.3	GPIO		AE	
	P2.4	GPIO	PWM0 <sub>H</sub>	MS0	
	P2.5	GPIO	PWM0⊾	MS1	
	P2.6	GPIO	PWM1 <sub>H</sub>	MS2	
	P2.7	GPIO	PWM1∟	MS3	
3	P3.0	GPIO	PWM0 <sub>H</sub>	AD0	PLAI[8]
	P3.1	GPIO	PWM0L	AD1	PLAI[9]
	P3.2	GPIO	PWM1 <sub>H</sub>	AD2	PLAI[10]
	P3.3	GPIO	PWM1∟	AD3	PLAI[11]
	P3.4	GPIO	PWM2 <sub>H</sub>	AD4	PLAI[12]
	P3.5	GPIO	PWM2⊾	AD5	PLAI[13]
	P3.6	GPIO	PWM <sub>TRIP</sub>	AD6	PLAI[14]
	P3.7	GPIO	PWM <sub>SYNC</sub>	AD7	PLAI[15]
4	P4.0	GPIO		AD8	PLAO[8]
	P4.1	GPIO		AD9	PLAO[9]
	P4.2	GPIO		AD10	PLAO[10]
	P4.3	GPIO		AD11	PLAO[11]
	P4.4	GPIO		AD12	PLAO[12]
	P4.5	GPIO		AD13	PLAO[13]
	P4.6	GPIO		AD14	PLAO[14]
	P4.7	GPIO		AD15	PLAO[15]

## Table 78. GPIO Pin Function Descriptions

<sup>1</sup>When configured in Mode 1, P0.7 is ECLK by default, or core clock output. To configure it as a clock input, the MDCLK bits in PLLCON must be set to 11. <sup>2</sup> The CONV<sub>START</sub> signal is active in all modes of P2.0.

### Table 79. GPxCON Registers

Name	Address	Default Value	Access
GP0CON	0xFFFFF400	0x0000000	R/W
GP1CON	0xFFFFF404	0x0000000	R/W
GP2CON	0xFFFFF408	0x0000000	R/W
GP3CON	0xFFFFF40C	0x0000000	R/W
GP4CON	0xFFFFF410	0x0000000	R/W

GPxCON are the Port x control registers, which select the function of each pin of Port x as described in Table 80.

#### Table 80. GPxCON MMR Bit Descriptions

Bit	Description
31:30	Reserved.
29:28	Select function of the Px.7 pin.
27:26	Reserved.
25:24	Select function of the Px.6 pin.
23:22	Reserved.
21:20	Select function of the Px.5 pin.
19:18	Reserved.
17:16	Select function of the Px.4 pin.
15:14	Reserved.
13:12	Select function of the Px.3 pin.
11:10	Reserved.
9:8	Select function of the Px.2 pin.
7:6	Reserved.
5:4	Select function of the Px.1 pin.
3:2	Reserved.
1:0	Select function of the Px.0 pin.

## Table 81. GPxPAR Registers

Name	Address	Default Value	Access
GP0PAR	0xFFFFF42C	0x20000000	R/W
GP1PAR	0xFFFFF43C	0x0000000	R/W

GPxPAR program the parameters for Port 0 and Port 1. Note that the GPxDAT MMR must always be written after changing the GPxPAR MMR.

## Table 82. GPxPAR MMR Bit Descriptions

Bit	Description
31	Reserved.
30:29	Drive strength Px.7.
28	Pull-Up Disable Px.7.
27	Reserved.
26:25	Drive strength Px.6.
24	Pull-Up Disable Px.6.
23	Reserved.
22:21	Drive strength Px.5.
20	Pull-Up Disable Px.5.
19	Reserved.
18:17	Drive strength Px.4.
16	Pull-Up Disable Px.4.
15	Reserved.
14:13	Drive strength Px.3.
12	Pull-Up Disable Px.3.
11	Reserved.
10:9	Drive strength Px.2.
8	Pull-Up Disable Px.2.
7	Reserved.
6:5	Drive strength Px.1.
4	Pull-Up Disable Px.1.
3	Reserved.
2:1	Drive strength Px.0.
0	Pull-Up Disable Px.0.

Tuble obt GI ADITI Registero			
Name	Address	Default Value <sup>1</sup>	Access
GP0DAT	0xFFFFF420	0x000000XX	R/W
GP1DAT	0xFFFFF430	0x000000XX	R/W
GP2DAT	0xFFFFF440	0x000000XX	R/W
GP3DAT	0xFFFFF450	0x000000XX	R/W
GP4DAT	0xFFFFF460	0x00000XX	R/W

## Table 85. GPxDAT Registers

<sup>1</sup>X = 0, 1, 2, or 3.

GPxDAT are Port x configuration and data registers. They configure the direction of the GPIO pins of Port x, set the output value for the pins configured as output, and store the input value of the pins configured as input.

## Table 86. GPxDAT MMR Bit Descriptions

Bit	Description
31:24	Direction of the data. Set to 1 by user to configure the GPIO pin as an output. Cleared to 0 by user to configure the GPIO pin as an input.
23:16	Port x data output.
15:8	Reflect the state of Port x pins at reset (read only).
7:0	Port x data input (read only).

### Table 87. GPxSET Registers

	0		
Name	Address	Default Value <sup>1</sup>	Access
GP0SET	0xFFFFF424	0x000000XX	W
GP1SET	0xFFFFF434	0x000000XX	W
GP2SET	0xFFFFF444	0x000000XX	W
GP3SET	0xFFFFF454	0x000000XX	W
GP4SET	0xFFFFF464	0x000000XX	W

 $^{1}X = 0, 1, 2, \text{ or } 3.$ 

GPxSET are data set Port x registers.

### Table 88. GPxSET MMR Bit Descriptions

Bit	Description
31:24	Reserved.
23:16	Data Port x set bit. Set to 1 by user to set bit on Port x; also sets the corresponding bit in the GPxDAT MMR. Cleared to 0 by user; does not affect the data out.
15:0	Reserved.

#### Table 89. GPxCLR Registers

Name	Address	Default Value <sup>1</sup>	Access
GP0CLR	0xFFFFF428	0x000000XX	W
GP1CLR	0xFFFFF438	0x000000XX	W
GP2CLR	0xFFFFF448	0x000000XX	W
GP3CLR	0xFFFFF458	0x000000XX	W
GP4CLR	0xFFFFF468	0x000000XX	W

 $^{1}X = 0, 1, 2, \text{ or } 3.$ 

GPxCLR are data clear Port x registers.

#### Table 90. GPxCLR MMR Bit Descriptions

Bit	Description
31:24	Reserved.
23:16	Data Port x clear bit. Set to 1 by user to clear bit on Port x; also clears the corresponding bit in the GPxDAT MMR. Cleared to 0 by user; does not affect the data out.
15:0	Reserved.

## **SERIAL PORT MUX**

The serial port mux multiplexes the serial port peripherals (an SPI, UART, and two I<sup>2</sup>Cs) and the programmable logic array (PLA) to a set of 10 GPIO pins. Each pin must be configured to one of its specific I/O functions as described in Table 91.

#### Table 91. SPM Configuration

	GPIO	UART	UART/I <sup>2</sup> C/SPI	PLA
SPMMUX	(00)	(01)	(10)	(11)
SPM0	P1.0	SIN	I2C0SCL	PLAI[0]
SPM1	P1.1	SOUT	I2C0SDA	PLAI[1]
SPM2	P1.2	RTS	I2C1SCL	PLAI[2]
SPM3	P1.3	CTS	I2C1SDA	PLAI[3]
SPM4	P1.4	RI	SCLK	PLAI[4]
SPM5	P1.5	DCD	MISO	PLAI[5]
SPM6	P1.6	DSR	MOSI	PLAI[6]
SPM7	P1.7	DTR	CS	PLAO[0]
SPM8	P0.7	ECLK/XCLK	SIN	PLAO[4]
SPM9	P2.0	CONV	SOUT	PLAO[5]

Table 91 also details the mode for each of the SPMMUX pins. This configuration must be done via the GP0CON, GP1CON, and GP2CON MMRs. By default, these 10 pins are configured as GPIOs.

## **UART SERIAL INTERFACE**

The UART peripheral is a full-duplex, universal, asynchronous receiver/transmitter. It is fully compatible with the 16,450 serial port standard. The UART performs serial-to-parallel conversions on data characters received from a peripheral device or modem, and parallel-to-serial conversions on data characters received from the CPU. The UART includes a fractional divider for baud rate generation and has a network addressable mode. The UART function is made available on the 10 pins of the ADuC7019/20/21/22/24/25/26/27/28/29 (see Table 92).

### Table 92. UART Signal Description

Pin	Signal	Description
SPM0 (Mode 1)	SIN	Serial receive data.
SPM1 (Mode 1)	SOUT	Serial transmit data.
SPM2 (Mode 1)	RTS	Request to send.
SPM3 (Mode 1)	CTS	Clear to send.
SPM4 (Mode 1)	RI	Ring indicator.
SPM5 (Mode 1)	DCD	Data carrier detect.
SPM6 (Mode 1)	DSR	Data set ready.
SPM7 (Mode 1)	DTR	Data terminal ready.
SPM8 (Mode 2)	SIN	Serial receive data.
SPM9 (Mode 2)	SOUT	Serial transmit data.

The serial communication adopts an asynchronous protocol, which supports various word lengths, stop bits, and parity generation options selectable in the configuration register.

## **Baud Rate Generation**

There are two ways of generating the UART baud rate, normal 450 UART baud rate generation and the fractional divider.

## Normal 450 UART Baud Rate Generation

The baud rate is a divided version of the core clock using the values in the COMDIV0 and COMDIV1 MMRs (16-bit value, DL).

Baud Rate = 
$$\frac{41.78 \text{ MHz}}{2^{\text{CD}} - 16 \times 2 \times \text{DL}}$$

Table 93 gives some common baud rate values.

Table 93. Baud Rate Using the Normal Baud Rate Generator
--

Baud Rate	CD	DL	Actual Baud Rate	% Error
9600	0	0x88	9600	0
19,200	0	0x44	19,200	0
115,200	0	0x0B	118,691	3
9600	3	0x11	9600	0
19,200	3	0x08	20,400	6.25
115,200	3	0x01	163,200	41.67

## **Fractional Divider**

The fractional divider, combined with the normal baud rate generator, produces a wider range of more accurate baud rates.



Figure 75. Baud Rate Generation Options

Calculation of the baud rate using fractional divider is as follows:

Baud Rate = 
$$\frac{41.78 \text{ MHz}}{2^{CD} \times 16 \times DL \times 2 \times \left(M + \frac{N}{2048}\right)}$$
$$M + \frac{N}{2048} = \frac{41.78 \text{ MHz}}{\text{Baud Rate} \times 2^{CD} \times 16 \times \text{DL} \times 2}$$

For example, generation of 19,200 baud with CD bits = 3 (Table 93 gives DL = 0x08) is

$$M + \frac{N}{2048} = \frac{41.78 \text{ MHz}}{19200 \times 2^3 \times 16 \times 8 \times 2}$$

$$M + \frac{N}{2048} = 1.06$$

where:

M = 1 $N = 0.06 \times 2048 = 128$ 

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Baud Rate = 
$$\frac{41.78 \text{ MHz}}{2}$$

$$2^{3} \times 16 \times 8 \times 2 \times \frac{128}{2048}$$

where:

Baud Rate = 19,200 bps

Error = 0%, compared to 6.25% with the normal baud rate generator.

## UART Register Definitions

The UART interface consists of 12 registers: COMTX, COMRX, COMDIV0, COMIEN0, COMDIV1, COMIID0, COMCON0, COMCON1, COMSTA0, COMSTA1, COMSCR, and COMDIV2.

### Table 94. COMTX Register

Name	Address	Default Value	Access
COMTX	0xFFFF0700	0x00	R/W

COMTX is an 8-bit transmit register.

### Table 95. COMRX Register

Name	Address	Default Value	Access
COMRX	0xFFFF0700	0x00	R

COMRX is an 8-bit receive register.

## Table 96. COMDIV0 Register

Name	Address	Default Value	Access
COMDIV0	0xFFFF0700	0x00	R/W

COMDIV0 is a low byte divisor latch. COMTX, COMRX, and COMDIV0 share the same address location. COMTX and COMRX can be accessed when Bit 7 in the COMCON0 register is cleared. COMDIV0 can be accessed when Bit 7 of COMCON0 is set.

### Table 97. COMIEN0 Register

Name	Address	Default Value	Access
COMIEN0	0xFFFF0704	0x00	R/W

COMIEN0 is the interrupt enable register.

### Table 98. COMIEN0 MMR Bit Descriptions

Bit	Name	Description
7:4	N/A	Reserved.
3	EDSSI	Modem status interrupt enable bit. Set by user to enable generation of an interrupt if any of COMSTA1[3:1] is set. Cleared by user.
2	ELSI	Rx status interrupt enable bit. Set by user to enable generation of an interrupt if any of COMSTA0[4:1] is set. Cleared by user.
1	ETBEI	Enable transmit buffer empty interrupt. Set by user to enable interrupt when buffer is empty during a transmission. Cleared by user.
0	ERBFI	Enable receive buffer full interrupt. Set by user to enable interrupt when buffer is full during a reception. Cleared by user.

Name	Address	Default Value	Access
I2C0ALT	0xFFFF0828	0x00	R/W
I2C1ALT	0xFFFF0928	0x00	R/W

I2CxALT are hardware general call ID registers used in slave mode.

## Table 139. I2C0CFG MMR Bit Descriptions

#### Bit Description Reserved. These bits should be written by the user as 0. 31:5 Enable stop interrupt. Set by the user to generate an interrupt upon receiving a stop condition and after receiving a valid start 14 condition and matching address. Cleared by the user to disable the generation of an interrupt upon receiving a stop condition. 13 Reserved. 12 Reserved. Enable stretch SCL (holds SCL low). Set by the user to stretch the SCL line. Cleared by the user to disable stretching of the SCL line. 11 10 Reserved. 9 Slave Tx FIFO request interrupt enable. Set by the user to disable the slave Tx FIFO request interrupt. Cleared by the user to generate an interrupt request just after the negative edge of the clock for the R/W bit. This allows the user to input data into the slave Tx FIFO if it is empty. At 400 ksps and the core clock running at 41.78 MHz, the user has 45 clock cycles to take appropriate action, taking interrupt latency into account. General call status bit clear. Set by the user to clear the general call status bits. Cleared automatically by hardware after the general 8 call status bits are cleared. 7 Master serial clock enable bit. Set by user to enable generation of the serial clock in master mode. Cleared by user to disable serial clock in master mode. 6 Loopback enable bit. Set by user to internally connect the transition to the reception to test user software. Cleared by user to operate in normal mode. 5 Start backoff disable bit. Set by user in multimaster mode. If losing arbitration, the master immediately tries to retransmit. Cleared by user to enable start backoff. After losing arbitration, the master waits before trying to retransmit. 4 Hardware general call enable. When this bit and Bit 3 are set and have received a general call (Address 0x00) and a data byte, the device checks the contents of I2C0ALT against the receive register. If the contents match, the device has received a hardware general call. This is used if a device needs urgent attention from a master device without knowing which master it needs to turn to. This is a "to whom it may concern" call. The ADuC7019/20/21/22/24/25/26/27/28/29 watch for these addresses. The device that requires attention embeds its own address into the message. All masters listen, and the one that can handle the device contacts its slave and acts appropriately. The LSB of the I2COALT register should always be written to 1, as indicated in The I<sup>2</sup>C-Bus Specification, January 2000, from NXP. 3 General call enable bit. This bit is set by the user to enable the slave device to acknowledge (ACK) an I<sup>2</sup>C general call, Address 0x00 (write). The device then recognizes a data bit. If it receives a 0x06 (reset and write programmable part of slave address by hardware) as the data byte, the I<sup>2</sup>C interface resets as as indicated in The I<sup>2</sup>C-Bus Specification, January 2000, from NXP. This command can be used to reset an entire I<sup>2</sup>C system. The general call interrupt status bit sets on any general call. The user must take corrective action by setting up the I<sup>2</sup>C interface after a reset. If it receives a 0x04 (write programmable part of slave address by hardware) as the data byte, the general call interrupt status bit sets on any general call. The user must take corrective action by reprogramming the device address. Reserved. 2 Master enable bit. Set by user to enable the master I<sup>2</sup>C channel. Cleared by user to disable the master I<sup>2</sup>C channel. 1 Slave enable bit. Set by user to enable the slave I<sup>2</sup>C channel. A slave transfer sequence is monitored for the device address in I2C0ID0, 0 I2C0ID1, I2C0ID2, and I2C0ID3. At 400 kSPs, the core clock should run at 41.78 MHz because the interrupt latency could be up to 45 clock cycles alone. After the I<sup>2</sup>C read bit, the user has 0.5 of an I<sup>2</sup>C clock cycle to load the Tx FIFO. AT 400 kSPS, this is 1.26 µs, the interrupt latency.

## Table 138. I2CxCFG Registers

Name	Address	Default Value	Access
I2C0CFG	0xFFFF082C	0x00	R/W
I2C1CFG	0xFFFF092C	0x00	R/W

I2CxCFG are configuration registers.

## FIQ

The fast interrupt request (FIQ) is the exception signal to enter the FIQ mode of the processor. It is provided to service data transfer or communication channel tasks with low latency. The FIQ interface is identical to the IRQ interface providing the second-level interrupt (highest priority). Four 32-bit registers are dedicated to FIQ: FIQSIG, FIQEN, FIQCLR, and FIQSTA.

## Table 165. FIQSTA Register

Name	Address	Default Value	Access
FIQSTA	0xFFFF0100	0x0000000	R

## Table 166. FIQSIG Register

Name	Address	Default Value	Access	
FIQSIG	0xFFFF0104	0x00XXX0001	R	
A				

<sup>1</sup>X indicates an undefined value.

## Table 167. FIQEN Register

Name	Address	Default Value	Access	
FIQEN	0xFFFF0108	0x0000000	R/W	

## Table 168. FIQCLR Register

Name	Address	Default Value	Access	
FIQCLR	0xFFFF010C	0x0000000	W	

Bit 31 to Bit 1 of FIQSTA are logically OR'd to create the FIQ signal to the core and to Bit 0 of both the FIQ and IRQ registers (FIQ source).

The logic for FIQEN and IRQEN does not allow an interrupt source to be enabled in both IRQ and FIQ masks. A bit set to 1 in FIQEN does, as a side effect, clear the same bit in IRQEN. Also, a bit set to 1 in IRQEN does, as a side effect, clear the same bit in FIQEN. An interrupt source can be disabled in both the IRQEN and FIQEN masks.

Note that to clear an already enabled FIQ source, the user must set the appropriate bit in the FIQCLR register. Clearing an interrupt's FIQEN bit does not disable the interrupt.

## **Programmed Interrupts**

Because the programmed interrupts are nonmaskable, they are controlled by another register, SWICFG, which simultaneously writes into the IRQSTA and IRQSIG registers and/or the FIQSTA and FIQSIG registers. The 32-bit SWICFG register is dedicated to software interrupts(see Table 170). This MMR allows the control of a programmed source interrupt.

### Table 169. SWICFG Register

Name	Address	Default Value	Access
SWICFG	0xFFFF0010	0x0000000	W

## Table 170. SWICFG MMR Bit Descriptions

Bit	Description
31:3	Reserved.
2	Programmed interrupt (FIQ). Setting/clearing this bit corresponds with setting/clearing Bit 1 of FIQSTA and FIQSIG.
1	Programmed interrupt (IRQ). Setting/clearing this bit corresponds with setting/clearing Bit 1 of IRQSTA and IRQSIG.
0	Reserved.

Note that any interrupt signal must be active for at least the equivalent of the interrupt latency time, which is detected by the interrupt controller and by the user in the IRQSTA/FIQSTA register.

## TIMERS

The ADuC7019/20/21/22/24/25/26/27/28/29 have four general-purpose timer/counters.

- Timer0
- Timer1
- Timer2 or wake-up timer
- Timer3 or watchdog timer

These four timers in their normal mode of operation can be either free running or periodic.

In free-running mode, the counter decreases from the maximum value until zero scale and starts again at the minimum value. (It also increases from the minimum value until full scale and starts again at the maximum value.)

In periodic mode, the counter decrements/increments from the value in the load register (TxLD MMR) until zero/full scale and starts again at the value stored in the load register.

The timer interval is calculated as follows:

If the timer is set to count down then

$$Interval = \frac{(TxLD) \times Prescaler}{Source Clock}$$

If the timer is set to count up, then

$$Interval = \frac{(Fs - TxLD) \times Prescaler}{Source Clock}$$

The value of a counter can be read at any time by accessing its value register (TxVAL). Note that when a timer is being clocked from a clock other than core clock, an incorrect value may be read (due to an asynchronous clock system). In this configuration, TxVAL should always be read twice. If the two readings are different, it should be read a third time to get the correct value.

Timers are started by writing in the control register of the corresponding timer (TxCON).

In normal mode, an IRQ is generated each time the value of the counter reaches zero when counting down. It is also generated each time the counter value reaches full scale when counting up. An IRQ can be cleared by writing any value to clear the register of that particular timer (TxCLRI).

When using an asynchronous clock-to-clock timer, the interrupt in the timer block may take more time to clear than the time it takes for the code in the interrupt routine to execute. Ensure that the interrupt signal is cleared before leaving the interrupt service routine. This can be done by checking the IRQSTA MMR.

## Hour:Minute:Second:1/128 Format

To use the timer in hour:minute:second:hundredths format, select the 32,768 kHz clock and prescaler of 256. The hundredths field does not represent milliseconds but 1/128 of a second (256/32,768). The bits representing the hour, minute, and second are not consecutive in the register. This arrangement applies to TxLD and TxVAL when using the hour:minute:second:hundredths format as set in TxCON[5:4]. See Table 171 for additional details.

## Table 171. Hour:Minnute:Second:Hundredths Format

Bit	Value	Description
31:24	0 to 23 or 0 to 255	Hours
23:22	0	Reserved
21:16	0 to 59	Minutes
15:14	0	Reserved
13.8	0 to 59	Seconds
7	0	Reserved
6:0	0 to 127	1/128 second

## Timer0 (RTOS Timer)

Timer0 is a general-purpose, 16-bit timer (count down) with a programmable prescaler (see Figure 77). The prescaler source is the core clock frequency (HCLK) and can be scaled by factors of 1, 16, or 256.

Timer0 can be used to start ADC conversions as shown in the block diagram in Figure 77.



#### Figure 77. Timer0 Block Diagram

# ADuC7019/20/21/22/24/25/26/27/28/29

The Timer0 interface consists of four MMRs: T0LD, T0VAL, T0CON, and T0CLRI.

## Table 172. T0LD Register

Name	Address	Default Value	Access	
TOLD	0xFFFF0300	0x0000	R/W	

T0LD is a 16-bit load register.

### Table 173. TOVAL Register

Name	Address	Default Value	Access	
TOVAL	0xFFFF0304	0xFFFF	R	

TOVAL is a 16-bit read-only register representing the current state of the counter.

## Table 174. TOCON Register

Name	Address	Default Value	Access	
T0CON	0xFFFF0308	0x0000	R/W	

T0CON is the configuration MMR described in Table 175.

## Table 175. TOCON MMR Bit Descriptions

Bit	Value	Description
15:8		Reserved.
7		Timer0 enable bit. Set by user to enable Timer0. Cleared by user to disable Timer0 by default.
6		Timer0 mode. Set by user to operate in periodic mode. Cleared by user to operate in free-running mode. Default mode.
5:4		Reserved.
3:2		Prescale.
	00	Core Clock/1. Default value.
	01	Core Clock/16.
	10	Core Clock/256.
	11	Undefined. Equivalent to 00.
1:0		Reserved.

### Table 176. T0CLRI Register

Name Address		Default Value Access		
TOCLRI	0xFFFF030C	0xFF	W	

TOCLRI is an 8-bit register. Writing any value to this register clears the interrupt.



Figure 84. External Memory Read Cycle with Address Hold and Bus Turn Cycles

# ADuC7019/20/21/22/24/25/26/27/28/29

Model <sup>1, 2</sup>	ADC Channels <sup>3</sup>	DAC Channels	FLASH/ RAM	GPIO	Down- loader	Temperature Range	Package Description	Package Option	Ordering Quantity
EVAL-ADuC7020MKZ							ADuC7020 MiniKit		
EVAL-ADuC7020QSZ							ADuC7020 QuickStart		
							Development System		
EVAL-ADuC7020QSPZ							ADuC7020 QuickStart		
							Development System		
EVAL-ADuC7024QSZ							ADuC7024 QuickStart		
							Development System		
EVAL-ADuC7026QSZ							ADuC7026 QuickStar		
							Development System		
EVAL-ADuC7026QSPZ							ADuC7026 QuickStart Plus		
							Development System		
EVAL-ADuC7028QSZ							ADuC7028 QuickStart		
							Development System		
EVAL-ADUC7029QSZ							ADuC7029 QuickStart		
							Development System		

 $^1$  Z = RoHS Compliant Part.  $^2$  Models ADuC7026 and ADuC7027 include an external memory interface.

<sup>3</sup> One of the ADC channels is internally buffered for ADuC7019 models.

I<sup>2</sup>C refers to a communications protocol originally developed by Phillips Semiconductors (now NXP Semiconductors).

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